

UV Laser Marking Machine

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Product Introduction

With small UV focus spot and heat affected zone, UV laser marking machine has high absorptivity to 355nm UV-light, which is suitable for many materials.

- High-performance ultraviolet laser and superior laser beam quality bring exquisite marking effect for customers;
- The rotary table shortens unit processing time. Customer benefits grow exponentially at the same time;
- Equipped with safety hood, it avoids physical injury of operators by misoperation and minimizes the safety risk;
- Small size and good cooling performance.

It's widely used in special materials marking, cutting and processing, such as all kinds of glass, LCD panel, textiles, chip ceramics, semiconductor wafers, IC grains, sapphires, polymer films, etc.

Tech Parameter

Model	LSU3EI
Average Output Power	≥3W@30KHZ
Wavelength	355nm
Frequency	1-100KHZ
Marking Area	70 x 70mm 110x110mm (Optional)
Min Linear Width	≤0.01mm
Max Linear Speed	≤7000mm/s
Power Supply	AC220V±15% 50Hz